

Electronic Acknowledgement Receipt

EFS ID:	3309917
Application Number:	10596387
International Application Number:	
Confirmation Number:	5987
Title of Invention:	Epoxy Resin Molding Material for Sealing and Electronic Component
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Attorney Docket Number:	MIYOSH0006
Receipt Date:	15-MAY-2008
Filing Date:	13-APR-2007
Time Stamp:	16:18:11
Application Type:	U.S. National Stage under 35 USC 371

Payment information:

Submitted with Payment	no
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Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement Letter	08-05-15_IDS_with_cert.pdf	71459 d502ce23715f1884284351d2bfeca3e0923c2177	no	3

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2	Information Disclosure Statement (IDS) Filed	08-05-15_US_IDS_Form__S B_08a.pdf	660337 1012d6a1ffd1db79b4968045359a9eee62aeddb5	no	4
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3	NPL Documents	08-05-15_NPL01_Office_acti on.pdf	485677 52909c6df10d282a717860aac1faec4e363b3679	no	10
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